







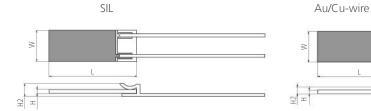


CONDUCTIVITY

Benefits & Characteristics

- High chemical resistance
- Wide temperature range
- Condensation resistant
- Fast recovery time
- Very low drift
- High humidity stability
- Suitable for extreme environments
- Customer specific sensor available upon request

Illustration¹⁾



Technical Data

Dimensions (L x W x H / H2 in mm):	SIL	10.8 x 3.81 x 0.4 / 1.2
	Au/Cu-wire	10.8 x 3.81 x 0.4 / 0.8
Operating humidity range:	0 % RH to 100 % RH (maximal dew point +95 °C)	
Operating temperature range:	-40 °C to +190 °C	
Capacitance (C ₃₀):*	300 pF ±40 pF (at 30 % RH and +23 °C)	
Sensitivity (at $C_{30} = 300 \text{ pF}$):	0.45 pF/% RH (15 %	6 RH to 90 % RH)
Loss factor:	< 0.01 (at 23 °C, at	10 kHz, at 90 % RH)
Linearity error:	< 2 % RH (15 % RH	I to 90 % RH at +23 °C after one point calibration)
Hysteresis:	< 2 % RH	
Response time t ₆₃ :	< 6 s (50 % RH to 0 % RH at +23 °C)	
Temperature dependence (typical):	Δ % RH = (B1 x % F	RH + B2) x T [°C] + (B3 x % RH + B4)
	B1 = 0.0011 [1/°C]	B2 = 0.0892 [% RH/°C]
	B3 = -0.0268	B4 = -2.079 [% RH]
Measurement frequency:	1 kHz to 100 kHz (re	ecommended 10 kHz)
Maximal supply voltage:	$< 12 V_{pp} AC$	
Signal form:	alternating signal without DC bias	
Connection:*	CuP-SIL-wire post-plated with Sn, 10 mm or Au/Cu-wire, Ø 0.4 mm	

* Customer specific alternatives available

The calibration of the sensor must be done 5 days after soldering at the earliest.

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¹⁾ For actual size, see dimensions





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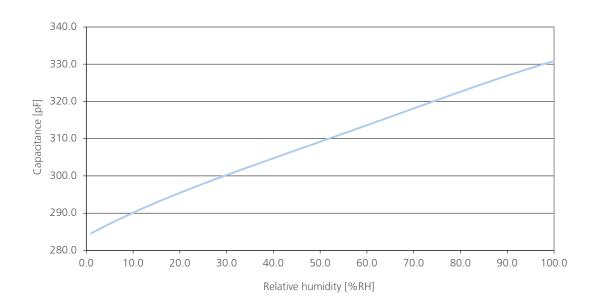






CONDUCTIVITY

Characteristic Curve



Order Information - SIL (CuP-SIL-wire post-plated with Sn, 10 mm)

	MK33 (300pF ±40pF)
Order code	040.00192

Order Information - Au/Cu-wire, Ø 0.4 mm

	MK33-W (300pF ±40pF)
Order code	040.00180





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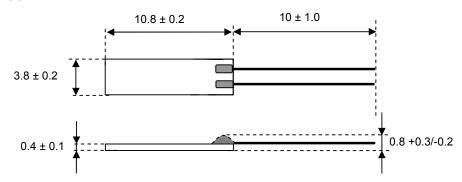






Construction Sizes

Dimension in mm









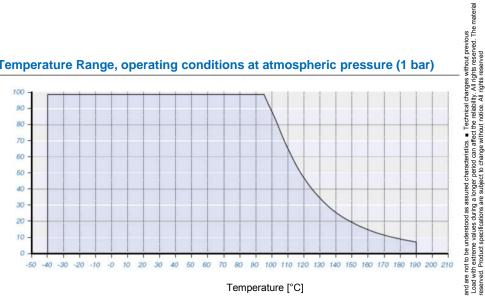






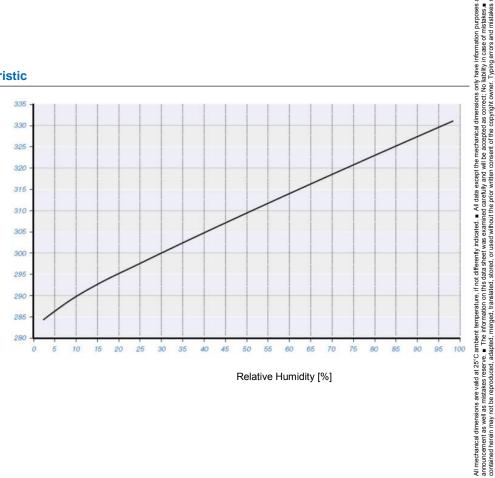
Allowed Humidity-Temperature Range, operating conditions at atmospheric pressure (1 bar)

Relative Humidity [%]



Sensor Characteristic

Capacitance [pF]



Relative Humidity [%]









MK33-W Capacitive Humidity Sensor Handling guideline





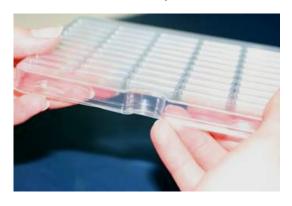


Packaging

The wired humidity sensors are packaged in blisters. Please be careful when opening the blisters to avoid any damages to the sensors.

To avoid damages please handle as follows:

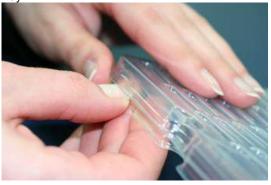
1. Side with curve has to face you.



2. Push your thumb beneath cover and press carefully lock system until cover removes smoothly.



3. Press lock system on second side on the same way.



4. Remove cover slowly.



Storage

Sensors have to be stored only in the original blisters.

Storage environment

-20°C...+50°C /-4...122°F (temperature range of blister)







MK33-W Capacitive Humidity Sensor Handling guideline

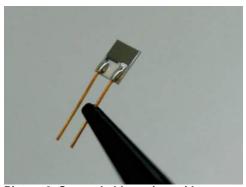




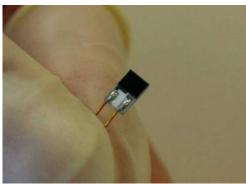


Sensor handling

Hold the sensor with plastic tweezers or with gloves on the wires only.



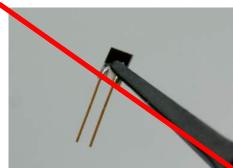
Picture 3: Sensor held on wires with plastic tweezers



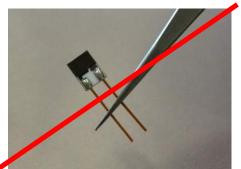
Picture 4: Sensor held with gloves

- Do not touch the active area of the sensor.
- Do not use metal tweezers to handle the sensors.
- Never handle the sensor by hand without gloves.

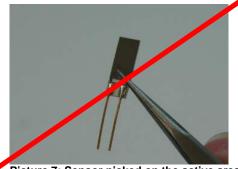
Pictures 5-8 are examples for forbidden handlings.



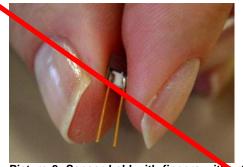
Picture 5: Sensor picked on the active area



Picture 6: Sensor picked on wires with metal tweezers



Picture 7: Sensor picked on the active area with metal tweezers



Picture 8: Sensor held with fingers with ut gloves on the active area







MK33-W Capacitive Humidity Sensor Handling guideline







Do not touch or scratch the active area of the sensors. Scratches and contaminations can degrade the sensor characteristic (see bad samples in pictures 9 and 10 below).



Picture 9: Sensor with contaminations



Picture 10: Sensor with a scratch

- Avoid mechanical stress to the sensors, e.g. bending or touching with sharp objects.
- Hold the sensors with plastic tweezers on the side edges only.

Soldering of the sensor

- The maximum temperature of the soldering iron of 320°C may not be exceeded. Maximum heat apply
 with the iron must be below 10 seconds at the very end of the connecting wires.
- The calibration of the sensors has to been done 5 days after soldering at earliest. This time is needed
 to provide a relaxation after the heat induces during the soldering process.
- Avoid soldering flux residues, caused by the soldering process, or any other contaminations inside the
 active area of the sensor.
- Soldering flux residues on the outside of the sensor's active area are not critical.
- If the sensor is mounted with glue we recommend baking the sensor at 80 °C for 1 hour after the gluing process.

Cleaning of the sensor

- Any residues can be easily removed with isopropanol at room temperature. Apply of low ultrasonic energy might improve the cleaning process. The sensor has to be dried after the cleaning process.
- The sensor cannot be cleaned mechanically with cotton swabs for instance.
- It is possible to clean the sensor with oil free and filtered clean air, e.g. for removing dust particles.



